7

6

П СОМР

] v_{cc+}

OUT

OFFSET N2

P PACKAGE (TOP VIEW)

N1/COMP

IN- **□** 2

IN+ 3

 V_{CC}

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- Low Power Consumption
- Wide Common-Mode and Differential Voltage Ranges
- Low Input Bias and Offset Currents
- Output Short-Circuit Protection
- Low Total Harmonic Distortion . . . 0.003% Typ
- High Input Impedance . . . JFET Input Stage
- External Frequency Compensation
- Common-Mode Input Voltage Range Includes V_{CC+}
- Latch-Up-Free Operation
- High Slew Rate . . . 13 V/μs Typ

description

The TL080 JFET-input operational amplifier incorporates well-matched, high-voltage JFET and bipolar transistors in an integrated circuit. This device features high slew rates, low input bias and offset currents, and a low offset-voltage temperature coefficient. Offset adjustment and external-compensation options are available.

The TL080C is characterized for operation from 0°C to 70°C.

AVAILABLE OPTIONS

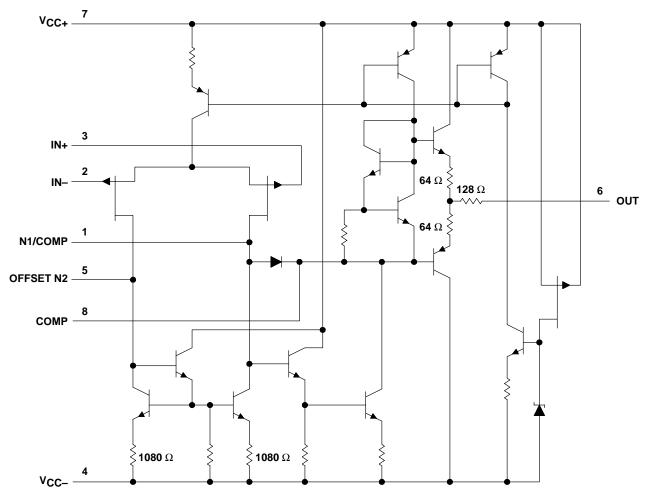
| | | PACKAGE | | |
|-------------|--------------------------------|-----------------------|--|--|
| TA | V _{IO} max AT 25°C | PLASTIC DIP (P) | | |
| 0°C to 70°C | 10 mV | TL080CP | | |



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schematic



All component values shown are nominal.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage (see Note 1): V _{CC+} | 18 V |
|--|----------------|
| V _{CC} | –18 V |
| Differential input voltage, V _{ID} (see Note 2) | ±30 V |
| Input voltage, V _I (see Notes 1 and 3) | ±15 √ |
| Duration of short-circuit current (see Note 4) | Unlimited |
| Package thermal impedance, θ _{JA} (see Notes 5 and 6) | 85°C/W |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C |
| Storage temperature range, T _{stq} | –65°C to 150°C |

- NOTES: 1. All voltage values, except differential voltages, are with respect to the midpoint between V_{CC+} and V_{CC-}.
 - 2. Differential voltages are at IN+ with respect to IN-.
 - 3. The magnitude of the input voltage must never exceed the magnitude of the supply voltage or 15 V, whichever is less.
 - 4. The output can be shorted to ground or to either supply. Temperature and/or supply voltages must be limited to ensure that the dissipation rating is not exceeded.
 - 5. Maximum power dissipation is a function of $T_J(max)$, θ_{JA} , and T_A . The maximum allowable power dissipation at any allowable ambient temperature is $P_D = (T_J(max) T_A)/\theta_{JA}$. Operating at the absolute maximum T_J of 150°C can impact reliability.
 - 6. The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics, $V_{CC\pm}$ = ±15 V (unless otherwise noted)

| | PARAMETER | TEST C | ONDITIONS | T _A † | MIN | TYP | MAX | UNIT |
|----------------------------------|---|--|-------------------|------------------|-----|--------------|-----|--------|
| VIO | Input offset voltage | Vo = 0 | Pa - 50 O | 25°C | | 3 | 15 | mV |
| VIO | input offset voltage | $V_O = 0$, $R_S = 50 \Omega$ | | Full range | | | 20 | IIIV |
| $\alpha_{V_{IO}}$ | Temperature coefficient of input offset voltage | $V_{O} = 0$, | $R_S = 50 \Omega$ | Full range | | 18 | | μV/°C |
| 10 | Input offset current‡ | V _O = 0 | | 25°C | | 5 | 200 | pА |
| 10 | input onset current+ | VO = 0 | | Full range | | | 2 | nA |
| I _{IB} | Input bias current ‡ $V_{O} = 0$ | | | 25°C | | 30 | 400 | pА |
| ПР | input bias current | 10-0 | | Full range | | | 10 | nA |
| VICR | Common-mode input voltage range | | | 25°C | ±11 | -12 to 15 | | ٧ |
| | | $R_L = 10 \text{ k}\Omega$ | | 25°C | ±12 | ±13.5 | | V |
| Vом | Maximum peak output voltage swing | $R_L \geq 10 \; k\Omega$ | | Full range | ±12 | | | |
| | | $R_L \ge 2 k\Omega$ | | | ±10 | ±12 | | |
| AVD | Large-signal differential voltage amplification | $V_O = \pm 10 \text{ V}, R_L \ge 2 \text{ k}\Omega$ | | 25°C | 25 | 200 | | V/mV |
| 7.00 | Large digital amore that voltage amplification | VO = ±10 V, | | Full range | 15 | | | */!!!* |
| B ₁ | Unity-gain bandwidth | | | 25°C | | 3 | | MHz |
| rį | Input resistance | | | 25°C | | 1012 | | Ω |
| CMRR | Common-mode rejection ratio | $V_{IC} = V_{ICR}$ $V_{O} = 0, R_{S}$ | | 25°C | 70 | 86 | | dB |
| k _{SVR} | Supply-voltage rejection ratio ($\Delta V_{CC\pm}/\Delta V_{IO}$) | $V_{CC} = \pm 15 \text{ V to } \pm 9 \text{ V},$ $V_{O} = 0, R_{S} = 50 \Omega$ | | 25°C | 70 | 86 | | dB |
| Icc | Supply current | $V_{O} = 0$, | No load | 25°C | | 1.4 | 2.8 | mA |
| V _{O1} /V _{O2} | Crosstalk attenuation | A _{VD} = 100 | | 25°C | | 120 | | dB |

[†] All characteristics are measured under open-loop conditions with zero common-mode voltage unless otherwise specified. Full range for T_A is -40°C to 85°C.

[‡] Input bias currents of a FET-input operational amplifier are normal junction reverse currents, which are temperature sensitive, as shown in Figure 5. Pulse techniques must be used that will maintain the junction temperature as close to the ambient temperature as possible.



[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

operating characteristics, $V_{CC\pm}$ = ±15 V, T_A = 25°C

| | PARAMETER | | MIN | TYP | MAX | UNIT | | |
|---|--------------------------------|--------------------------|--|--------------|-----|--------|---|--------------------|
| SR | Slew rate at unity gain | V _I = 10 V, | $R_L = 2 \text{ k}\Omega$, $C_L = 100 \text{ pF}$, | See Figure 1 | 8 | 13 | | V/μs |
| t _r Rise-time overshoot factor | | \/. 20 m\/ | $R_I = 2 k\Omega$, $C_I = 100 pF$, | Coo Figure 1 | | 0.05 | | μs |
| | | $V_{I} = 20 \text{ mV},$ | KL = 2 KS2, CL = 100 pr, | See Figure 1 | | 20% | | |
| V Favivalent innut naise valtage | | $R_S = 100 \Omega$ | f = 1 kHz | | | 18 | | nV/√ Hz |
| V _n | Equivalent input noise voltage | KS = 100 22 | f = 10 Hz to 10 kHz | | | 4 | | μV |
| In | Equivalent input noise current | $R_S = 100 \Omega$, | f = 1 kHz | · | | 0.01 | · | pA/√ Hz |
| THD | Total harmonic distortion | $V_{O(rms)} = 10 V,$ | $R_{\mbox{S}} \leq 1 \ \mbox{k} \Omega, R_{\mbox{L}} \geq 2 \ \mbox{k} \Omega, \label{eq:RS}$ | f = 1 kHz | C | 0.003% | · | |

APPLICATION INFORMATION

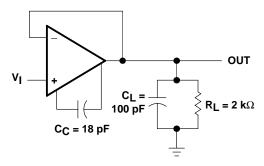


Figure 1. Unity-Gain Amplifier

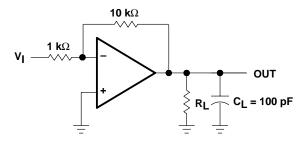


Figure 2. Gain-of-10 Inverting Amplifier

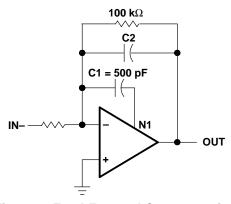


Figure 3. Feed-Forward Compensation

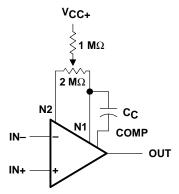


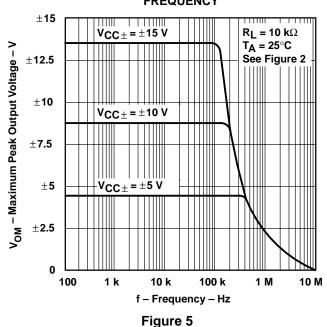
Figure 4. Input Offset Voltage Null Circuit

Table of Graphs

| | | | FIGURE |
|---|------------------------------------|--|-------------------------|
| Vом | Maximum peak output voltage | vs Frequency vs Free-air temperature vs Load resistance vs Supply voltage | 5, 6, 7 8 9 10 |
| Large-signal differential voltage amplification | | vs Free-air temperature vs Frequency | 11 12 |
| | Differential voltage amplification | vs Frequency | 13 |
| PD | Total power dissipation | vs Free-air temperature | 14 |
| lcc | Supply current | vs Free-air temperature vs Supply voltage | 14 15 |
| I _{IB} | Input bias current | vs Free-air temperature | 16 |
| | Large-signal pulse response | vs Time | 17 |
| VO | Output voltage | vs Elapsed time | 18 |
| CMRR | Common-mode rejection ratio | vs Free-air temperature | 19 |
| Vn | Equivalent input noise voltage | vs Frequency | 20 |
| THD | Total harmonic distortion | vs Frequency | 21 |

MAXIMUM PEAK OUTPUT VOLTAGE

vs FREQUENCY



MAXIMUM PEAK OUTPUT VOLTAGE

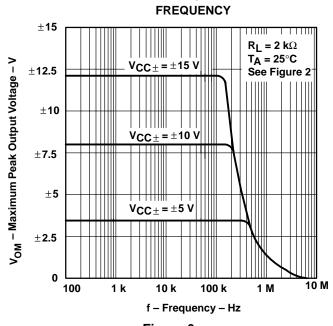
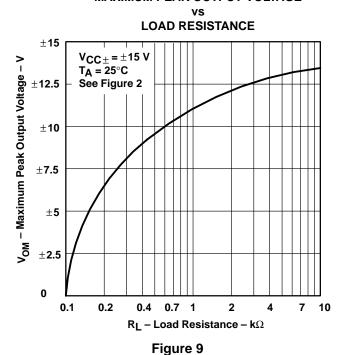


Figure 6

MAXIMUM PEAK OUTPUT VOLTAGE vs **FREQUENCY** ±15 $V_{CC\pm}$ = ±15 VV_{OM} - Maximum Peak Output Voltage - V $R_L = 2 k\Omega$ T_A = 25°C ±12.5 See Figure 2 ±10 $T_A = -55^{\circ}C$ ± 7.5 T_A = 125°C $\pm \mathbf{5}$ ± 2.5 10 k 40 k 100 k 400 k 1 M 4 M 10 M f - Frequency - Hz



Figure 7



MAXIMUM PEAK OUTPUT VOLTAGE

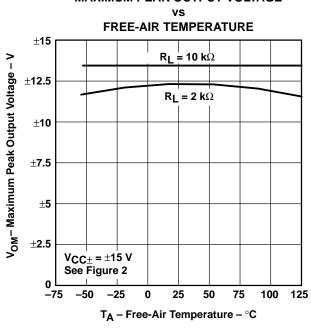


Figure 8

MAXIMUM PEAK OUTPUT VOLTAGE vs

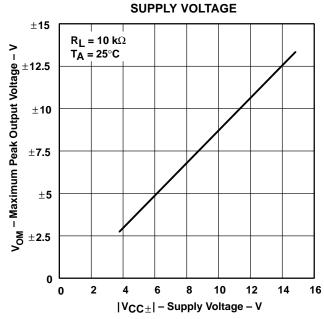
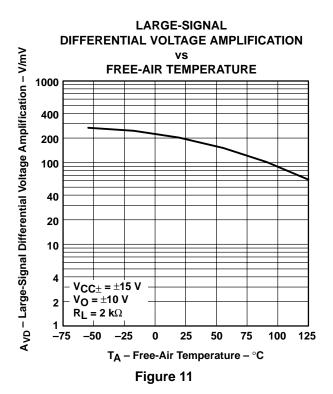
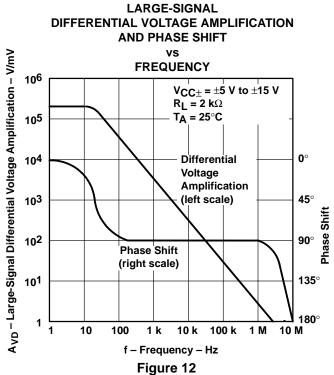
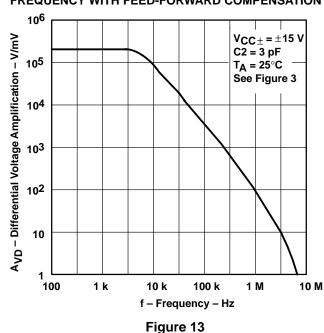


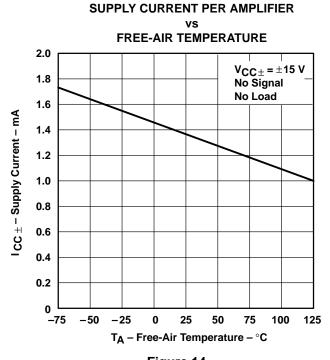
Figure 10

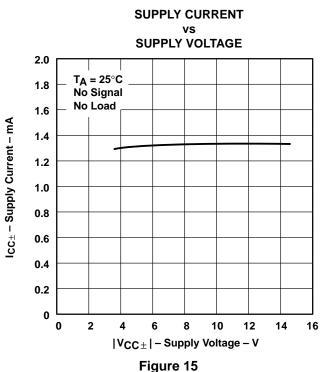




DIFFERENTIAL VOLTAGE AMPLIFICATION vs FREQUENCY WITH FEED-FORWARD COMPENSATION



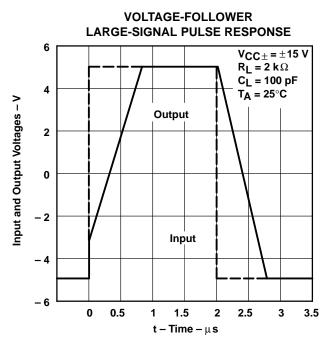




INPUT BIAS CURRENT FREE-AIR TEMPERATURE 100 $V_{CC\pm} = \pm 15 V$ I_{IB} - Input Bias Current - nA 10 0.1 0.01 - 25 - 50 25 50 75 100 125 TA - Free-Air Temperature - °C

•





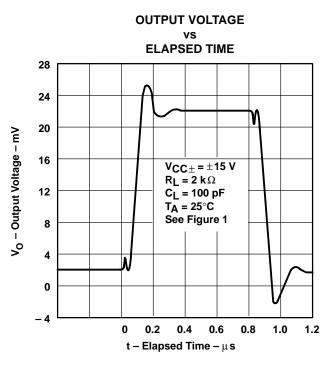
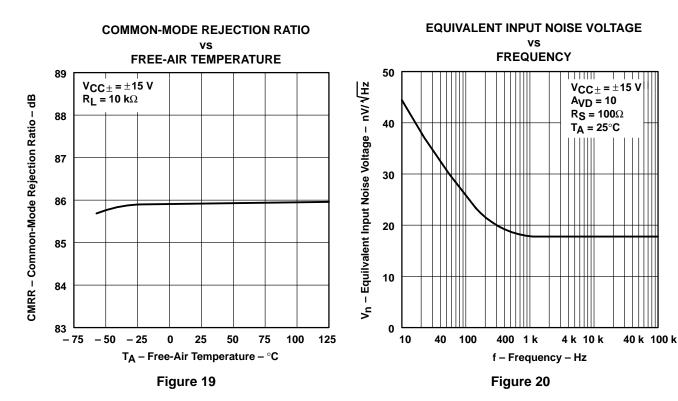


Figure 17

Figure 18





TOTAL HARMONIC DISTORTION

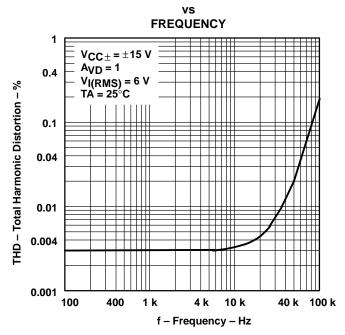




Figure 21

APPLICATION INFORMATION

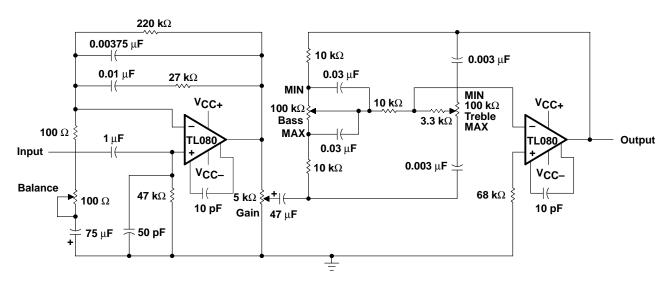


Figure 22. IC Preamplifier







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PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins P | Package Qty | Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|--------|----------------|-------------------------|------------------|------------------------------|
| TL080CP | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL080CPE4 | ACTIVE | PDIP | Р | 8 | 50 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type |
| TL080IP | OBSOLETE | PDIP | Р | 8 | | TBD | Call TI | Call TI |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. Falls within JEDEC MS-001

For the latest package information, go to http://www.ti.com/sc/docs/package/pkg_info.htm

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